

# **Low Skew Output Buffer**

## **General Description**

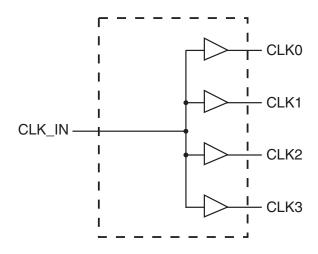
The ICS9112-26 is a high performance, low skew, low jitter clock driver. It is designed to distribute high speed clocks in PC systems operating at speeds from 0 to 133 MHz.

The ICS9112-26 comes in an eight pin 150 mil SOIC package. It has four output clocks.

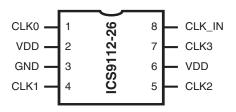
## **Features**

- Frequency range 0 133 MHz (3.3V)
- Less than 200 ps Jitter between outputs
- Skew controlled outputs
- Skew less than 250 ps between outputs
- Available in 8 pin 150 mil SOIC & 173 mil TSSOP packages.
- $3.3V \pm 10\%$  operation

## **Block Diagram**



## Pin Configuration



8 pin SOIC & TSSOP

## **Pin Descriptions**

PIN NUMBER	PIN NAME	TYPE	DESCRIPTION
1	CLK01	OUT	Buffered clock output
2,6	VDD	PWR	Power Supply (3.3V)
3	GND	PWR	Ground
4	CLK1 <sup>1</sup>	OUT	Buffered clock output
5	CLK2 <sup>1</sup>	OUT	Buffered clock output
7	CLK3 <sup>1</sup>	OUT	Buffered clock output
8	CLK_IN	IN	Input reference frequency.

### Notes:

1. Weak pull-down on all outputs



## **Absolute Maximum Ratings**

Supply Voltage ...... 7.0 V

Ambient Operating Temperature . . . . . . 0°C to +70°C

Storage Temperature . . . . . . . . . . . . . . . .  $-65^{\circ}$ C to  $+150^{\circ}$ C

Stresses above those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These ratings are stress specifications only and functional operation of the device at these or any other conditions above those listed in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect product reliability.

### Electrical Characteristics at 3.3V

 $T_A = 0 - 70C$ ; Supply Voltage  $V_{DD} = 3.3 \text{ V} + 1.5\%$  (unless otherwise stated)

PARAMETER	SYMBOL	CONDITIONS		TYP	MAX	UNITS
		$V_{\rm DD}$ = min to max, $I_{\rm OH}$ = -1 mA	$V_{\rm DD}$ - $0.2$	3.3		V
High-level Output Voltage	$V_{OH}$	$V_{DD} = 3V$ , $I_{OH} = -24 \text{ mA}$	2	2.9		V
		$V_{\rm DD} = 3V, I_{\rm OH} = 12 \text{ mA}$	2.4	3.1		V
		$V_{\rm DD}$ = min to max, $I_{\rm OH}$ = 1 mA		0.0055	0.2	V
Low-level Output Voltage	$V_{OL}$	$V_{\rm DD} = 3V, I_{\rm OH} = 24 \text{ mA}$		0.28	0.8	V
		$V_{DD} = 3V, I_{OH} = 12 \text{ mA}$		0.14	0.55	V
High lavel Input Cument	$I_{OH}$	$V_{DD} = 3V, V_{O} = 1V$		-61	-50	
High-level Input Current		$V_{DD} = 3.3V, V_{O} = 1.65V$		-77		
Lavi laval Innut Cumant	т	$V_{DD} = 3V, V_{O} = 2V$	60	103		
Low-level Input Current	$I_{OL}$	$V_{DD} = 3.3 V, V_{O} = 1.65 V$		111		
Input Current	$I_{\mathrm{I}}$	$V = V_O \text{ or } V_{DD}$	-5		5	μΑ
Input Capacitance <sup>1</sup>	$C_{\rm I}$	$V_{DD} = 3.3V, V_{I} = 0V \text{ or } 3.3V$		3		pF
Output Capacitance <sup>1</sup>	CO	$V_{DD} = 3.3V, V_{I} = 0V \text{ or } 3.3V$		3.2		pF
Supply current	$I_{DD}$	REF = 0 MHz		22	50	μΑ
Supply cultent	*DD	Unloaded outputs at 66.67 MHz		25	40	mA

<sup>1.</sup> Guaranteed by design, not 100% tested in production.

## **Switching Characteristics at 3.3V**

 $T_A = 0 - 70C$ ; Supply Voltage  $V_{DD} = 3.3 \text{ V} + /-5\%$  (unless otherwise stated)

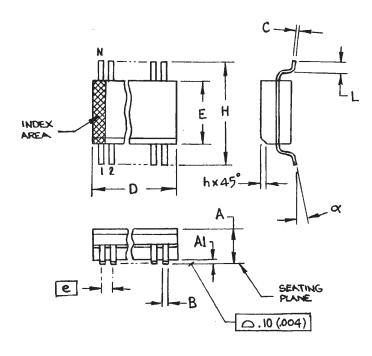
PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Low-to-high Propagation Delay <sup>1</sup>	t <sub>PLH</sub>	$V_O = V_{DD}/2$	4	5.6	7	ns
High-to-low Propagation Delay <sup>1</sup>	$t_{PHL}$	$V_O = V_{DD}/2$	4	5.2	7	ns
Output Skew Window <sup>1</sup>	$T_{sk}(O)$	$V_O = V_{DD}/2$		50	100	ps
Process Skew <sup>1</sup>	$T_{sk}(PR)$	$V_O = V_{DD}/2$			0.5	ps
CLKIN High Time <sup>1</sup>	$T_{high}$	66 MHz	6			ns
		133 MHz	3			113
CLKIN Low Time <sup>1</sup>	$T_{ m low}$	66 MHz	6			ne
CLKIN LOW TIME		133 MHz	3			ns
Output Rise Slew Rate <sup>1</sup>	$T_{r}$	$0.3$ to $0.6~V_{DD}$	2	3.6	5	V/ns
Output Rise Slew Rate <sup>1</sup>	$T_{\mathrm{f}}$	$0.3$ to $0.6~V_{DD}$	2	3.2	5	V/ns

<sup>1.</sup> Guaranteed by design, not 100% tested in production.

#### Notes

- 1. Guaranteed by design and characterization. Not subject to 100% test.
- 2. CLK\_IN input has a threshold voltage of 1.4V
- 3. All parameters expected with loaded outputs





SYMBOL	In Millimeters COMMON DIMENSIONS		In Inches COMMON DIMENSIO	
	MIN	MAX	MIN	MAX
Α	1.35	1.75	.0532	.0688
A1	0.10	0.25	.0040	.0098
В	0.33	0.51	.013	.020
С	0.19	0.25	.0075	.0098
D	SEE VARIATIONS		SEE VARIATIONS	
E	3.80	4.0	.1497	.1574
е	1.27 BASIC		0.050 BASIC	
Н	5.80	6.20	.2284	.2440
h	0.25	0.50	.010	.020
L	0.40	1.27	.016	.050
N	SEE VARIATIONS		SEE VARIATIONS	
α	0°	8°	0° 8°	

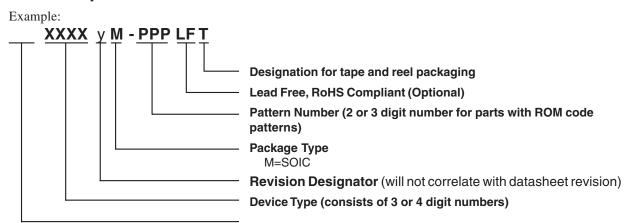
### **VARIATIONS**

N	D mm.		D (inch)		
	MIN	MAX	MIN	MAX	
8	4.80	5.00	.1890	.1968	

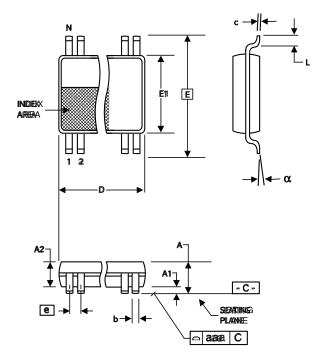
150 mil (Narrow Body) SOIC

# **Ordering Information**

9112yM-26LFT







4.40 mm. Body, 0.65 mm. pitch TSSOP (173 mil) (0.0256 mil)

SYMBOL	In Millimeters COMMON DIMENSIONS		In Inches COMMON DIMENSION	
	MIN	MAX	MIN	MAX
Α	-	1.20	-	.047
A1	0.05	0.15	.002	.006
A2	0.80	1.05	.032	.041
b	0.19	0.30	.007	.012
С	0.09	0.20	.0035	.008
D	SEE VARIATIONS SEE VARIATION		RIATIONS	
Е	6.40 E	BASIC	ASIC 0.252 BASIC	
E1	4.30	4.50	.169 .177	
е	0.65 BASIC		0.0256	BASIC
L	0.45	0.75	.018	.030
N	SEE VARIATIONS		SEE VAF	RIATIONS
α	0°	8°	0° 8°	
aaa	-	0.10	004	

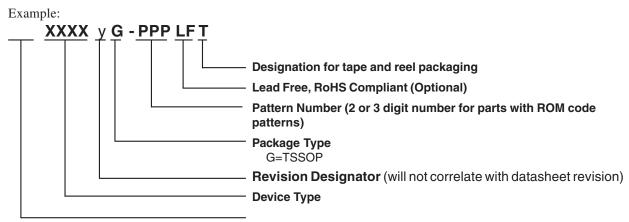
### **VARIATIONS**

N	D mm.		D (inch)		
	MIN	MAX	MIN	MAX	
8	2.90	3.10	.114	.122	

MO-153 JEDEC 7/6/00 Rev E Doc.# 10-0038

# **Ordering Information**

9112yG-<u>2</u>6LFT





**Revision History** 

Rev.	Issue Date	Description	Page #
С	04/17/07	Added LF to Ordering Information.	•
D	05/14/07	Updated Ordering Information.	3-4

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